

R5011FNX

Nch 500V 11A Power MOSFET

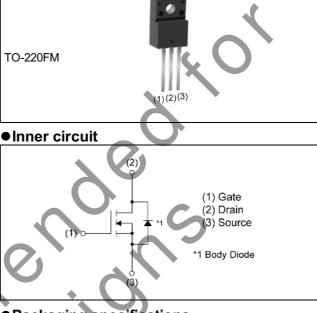
		Outline
V _{DSS}	500V	
R _{DS(on)} (Max.)	0.52Ω	
Ι _D	±11A	TO-220FM
P _D	59W	-

Features

- 1) Fast reverse recovery time(t_{rr}).
- 2) Low on-resistance.
- 3) Fast switching speed.
- 4) Gate-source voltage (V_{GSS}) guaranteed to be ± 30 V.
- 5) Drive circuits can be simple.
- 6) Parallel use is easy.

Application

Switching



Packaging specifications

G	Packing	Bulk
	Reel size (mm)	-
	Tape width (mm)	-
е	Basic ordering unit (pcs)	500
	Taping code	-
	Marking	R5011FNX

• Absolute maximum ratings (T_a = 25°C ,unless otherwise specified)

Parameter		Symbol	Value	Unit
Drain - Source voltage		V _{DSS}	500	V
	T _C = 25°C	۱ _D *1	±11	А
Continuous drain current	T _C = 100°C	۱ _D *1	±5.4	А
Pulsed drain current		۱ _{DP} *2	±44	А
Gate - Source voltage		V _{GSS}	±30	V
Avalanche current, repetitive		I _{AR} *3	5.5	А
Avalanche energy, single pulse	E_{AS}^{*3}	8.1	mJ	
Avalanche energy, repetitive	E_{AR}^{*5}	3.5	mJ	
Power dissipation ($T_C = 25^{\circ}C$)		P _D *4	59	W
Junction temperature		Тj	150	°C
Operating junction and storage tempe	erature range	T _{stg}	-55~+150	°C

• Absolute maximum ratings ($T_a = 25^{\circ}C$)

Parameter	Parameter Symbol		Conditions		IS	Values	Unit
Reverse diode dv/dt	d	v/dt		-		15	V/ns
Drain - Source voltage slope	dv/dt V _{DS} = 400V, T _j = 125°C		= 125°C	50	V/ns		
●Thermal resistance					5	0)	
Parameter		Syn	nbol	Min.	Values Typ.	Max.	Unit
Thermal resistance, junction - case		Rt	hJC	\mathcal{O}	-	2.10	°C/W
Thermal resistance, junction - ambient		R	thJA		-	70	°C/W
Soldering temperature, wavesoldering for 10	s	T,	sold	-		265	°C
●Electrical characteristics (T _a = 25°C)		0		. <	9		

•Electrical characteristics (T_a = 25°C)

Parameter	Symbol	Symbol Conditions		Values		
	Symbol	Conditions	Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 1mA	500	-	-	V
Zero gate voltage drain current	I _{DSS}	V _{DS} = 500V, V _{GS} = 0V T _j = 25°C T _i = 125°C	-	1 -	100 10000	μΑ
Gate - Source leakage current	I _{GSS}	V _{GS} = ±30V, V _{DS} = 0V	-	-	±100	nA
Gate threshold voltage	V _{GS(th)}	V _{DS} = 10V, I _D = 1mA	2.0	-	4.0	V
Static drain - source on - state resistance	R _{DS(on)} *6	V _{GS} = 10V, I _D = 5.5A T _j = 25°C T _j = 125°C	-	0.40 0.85	0.52	Ω
Gate resistance	R _G	f =1MHz, open drain	-	8.8	-	Ω

9



• Electrical characteristics (T_a = 25°C)

Devenueter	Current al	Conditions		Values		Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Forward Transfer Admittance	Y _{fs} * ⁶	V _{DS} = 10V, I _D = 5.5A	4.5	-	- ~	S	
Input capacitance	C _{iss}	V _{GS} = 0V	-	950	\bigcirc		
Output capacitance	C _{oss}	V _{DS} = 25V	-	580	-	pF	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	30	-		
Effective output capacitance, energy related	C _{o(er)}	V _{GS} = 0V	0	50.8	-		
Effective output capacitance, time related	C _{o(tr)}	V _{DS} = 0V to 400V)	51.2	-	pF	
Turn - on delay time	t _{d(on)} *6	$V_{DD} \simeq 250V, V_{GS} = 10V$		26	-		
Rise time	t _r *6	I _D = 5.5A		28	-	nc	
Turn - off delay time	t _{d(off)} *6	R _L ≃ 45.5Ω		75	-	ns	
Fall time	t _f *6	R _G = 10Ω	-	30	-		

• Gate charge characteristics ($T_a = 25^{\circ}C$)

Deremeter	Symbol	Conditions		Values		Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Total gate charge	Q_{g}^{*6}	V _{DD} ≃ 250V,	-	30	-	
Gate - Source charge	Q_{gs}^{*6}	I _D = 11A,	-	7	-	nC
Gate - Drain charge	Q _{gd} *6	V _{GS} = 10V	-	12	-	
Gate plateau voltage	V _(plateau)	V _{DD} = 250V, I _D = 11A	-	5.9	-	V

V

*1 Limited only by maximum channel temperature allowed.

*2 Pw \leq 10µs, Duty cycle \leq 1%

*3 L \doteqdot 500µH, V_{DD}=50V, R_G=25 Ω , STARTING T_j=25°C

*4 T_C=25°C

*5 L \doteqdot 500µH, V_{DD}=50V, R_G=25 Ω , STARTING T_j=25°C, f=10kHz

*6 Pulsed





Unit

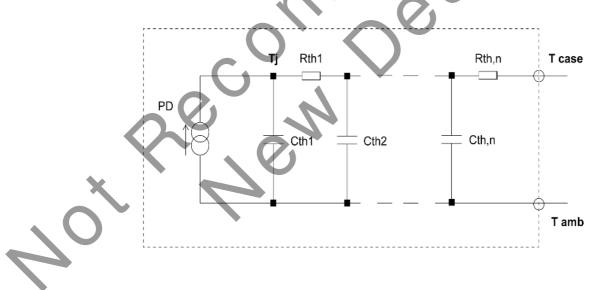
Ws/K

•Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Parameter	Sumbol	Conditions			Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Continuous forward current	۱ _S *1	T - 25°0	-	-	11	А
Pulse forward current	۱ _{SP} *2	T _c = 25°C	-	Ţ	44	A
Forward voltage	V_{SD}^{*6}	V _{GS} = 0V, I _S = 11A	-	-	1.5	V
Reverse recovery time	t _{rr} *6		55	85	115	ns
Reverse recovery charge	Q _{rr} *6	I _S = 11A, V _{GS} =0V di/dt = 100A/µs		0.33	-	μC
Peak reverse recovery current	I _{mm} *6		N	7.4	-	А

•Typical Transient Thermal Characteristics

Symbol	Value	Unit	Symbol	Value	
R _{th1}	0.178		C _{th1}	0.00269	
R _{th2}	0.853	K/W	C _{th2}	0.0273	,
R _{th3}	2.36		C _{th3}	0.463	





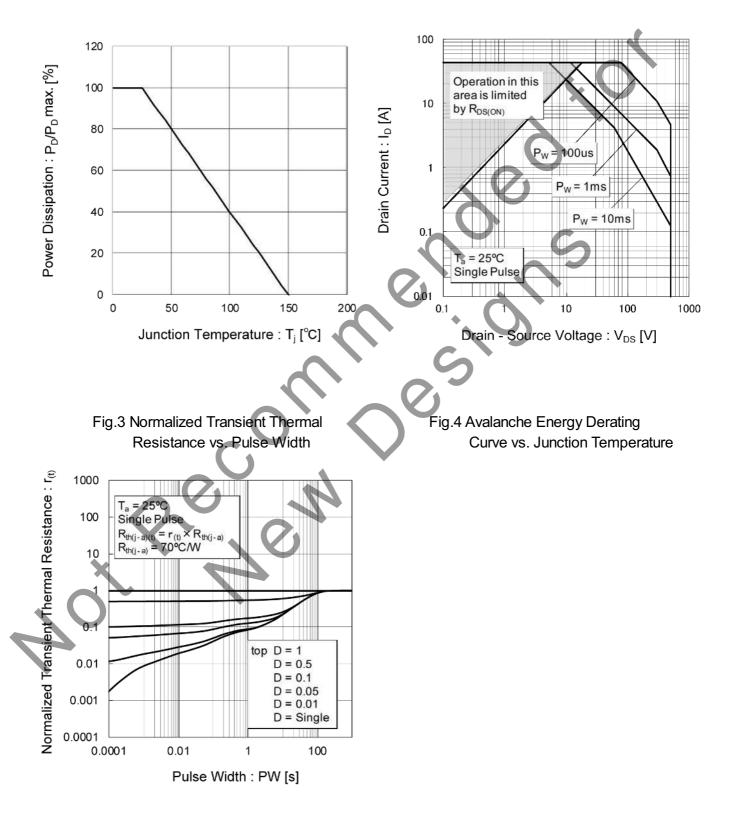


Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area



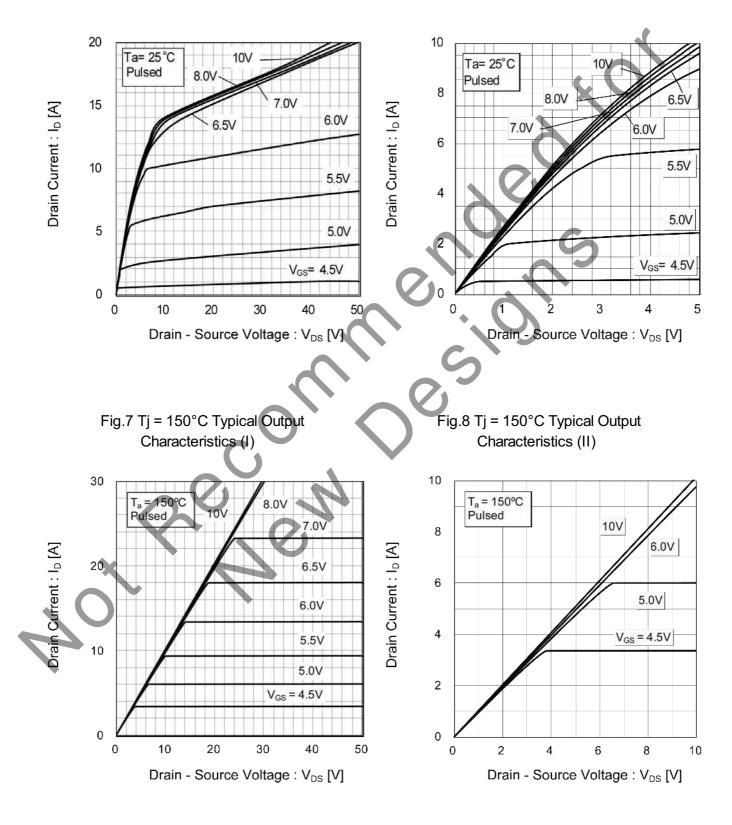


Fig.5 Typical Output Characteristics(I)

Fig.6 Typical Output Characteristics(II)





Fig.9 Breakdown Voltage vs.

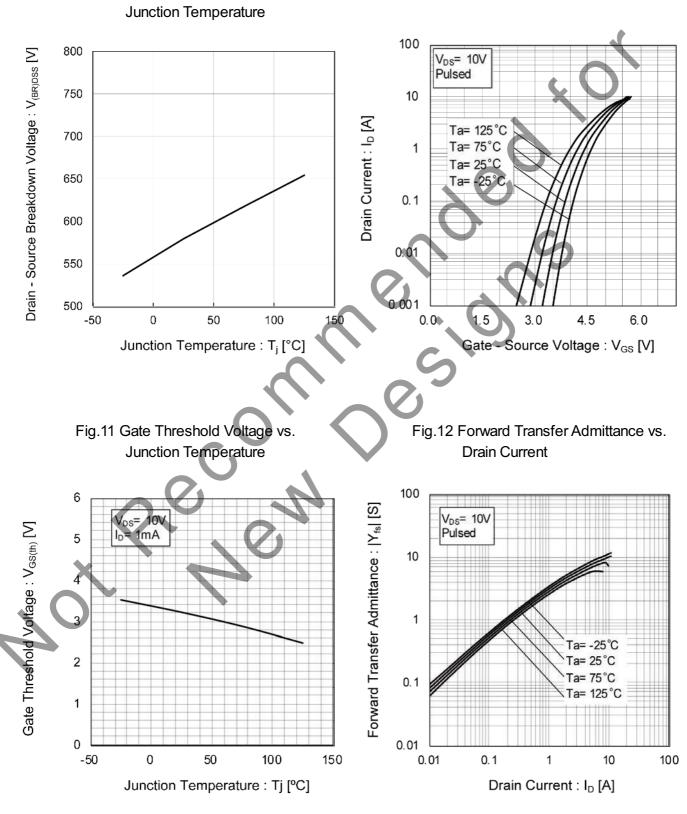
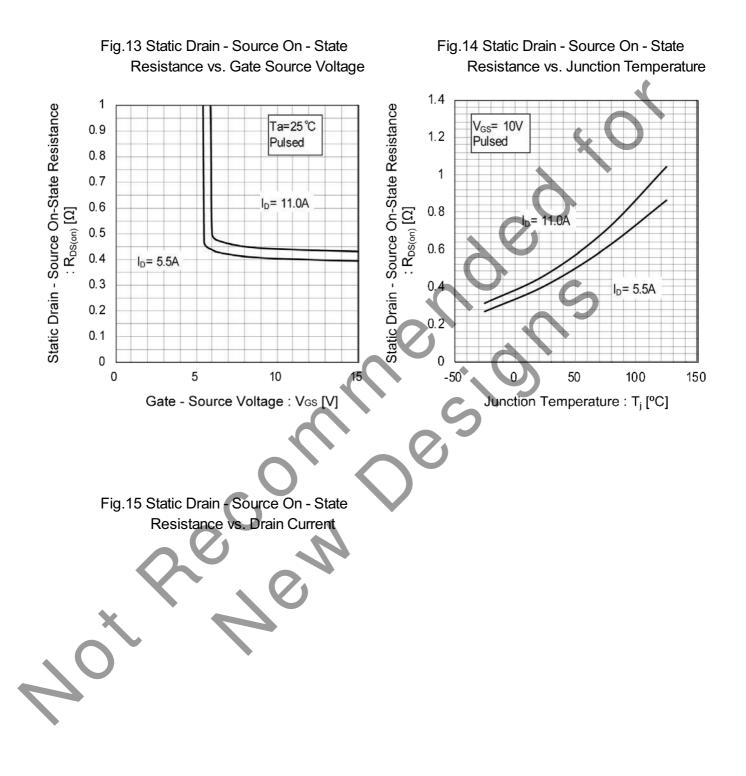


Fig.10 Typical Transfer Characteristics





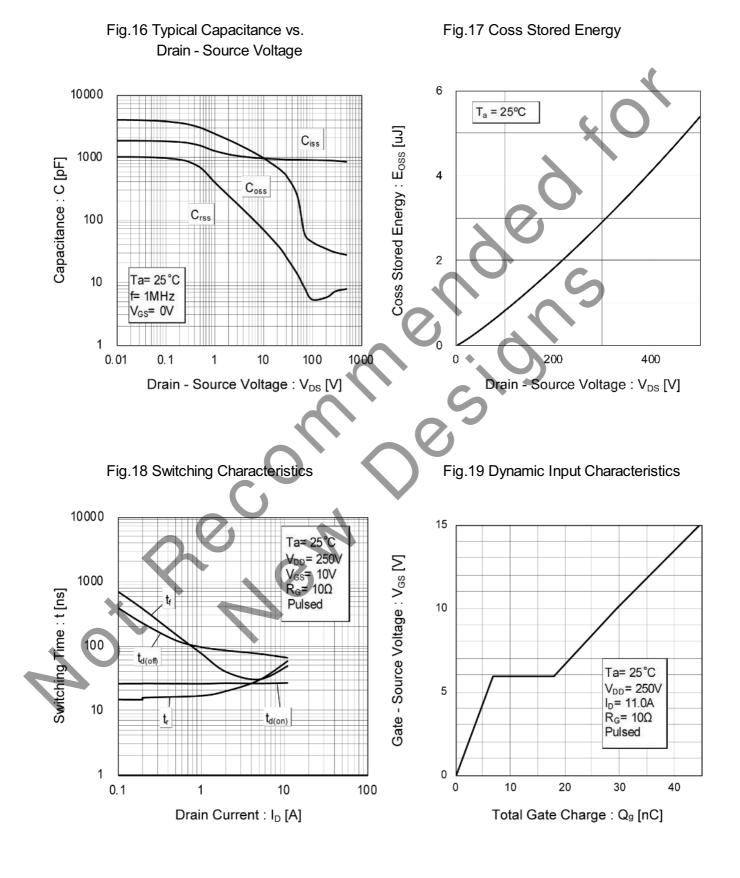




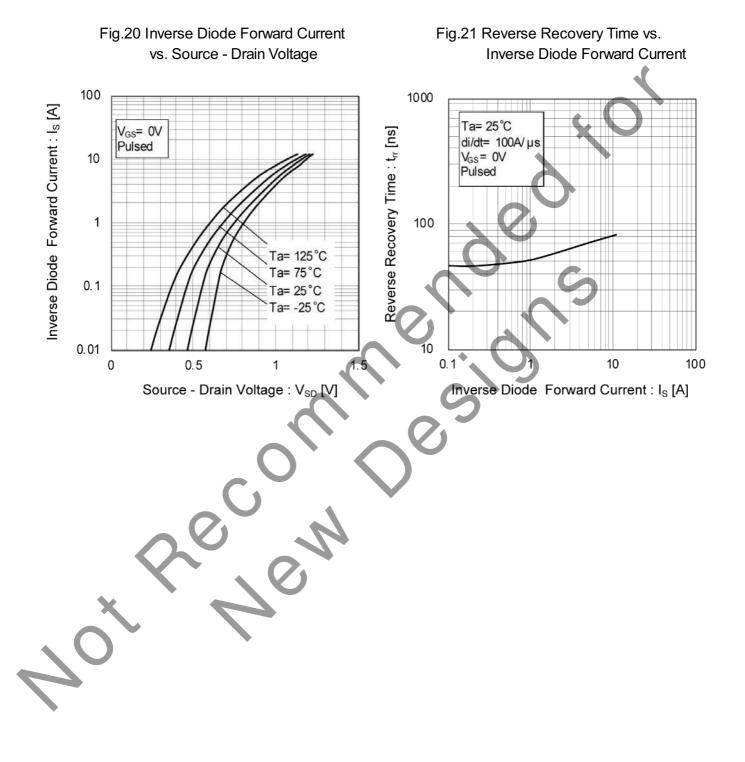
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• Electrical characteristic curves

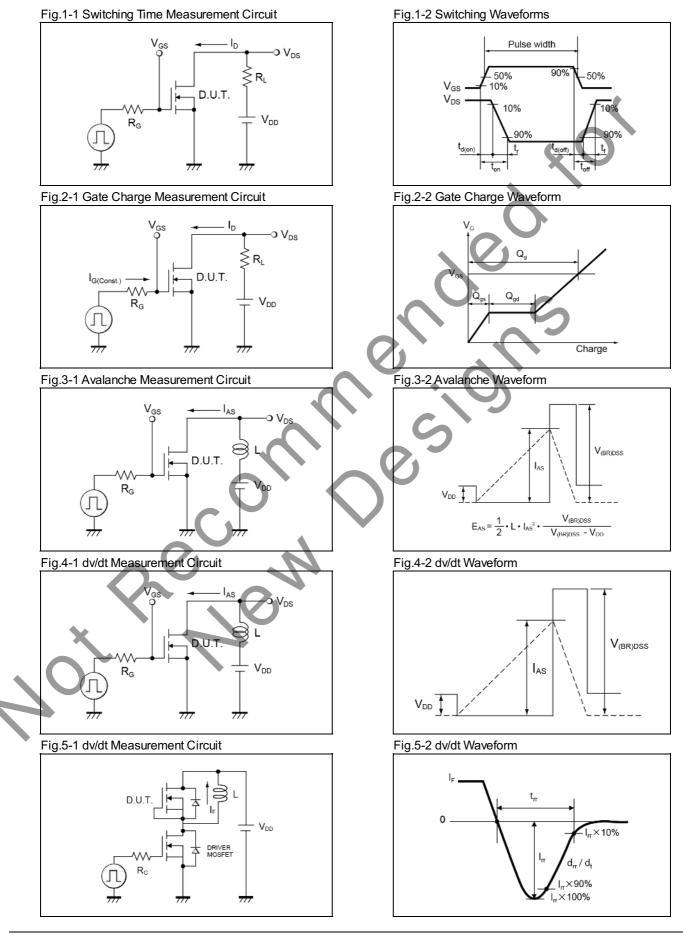






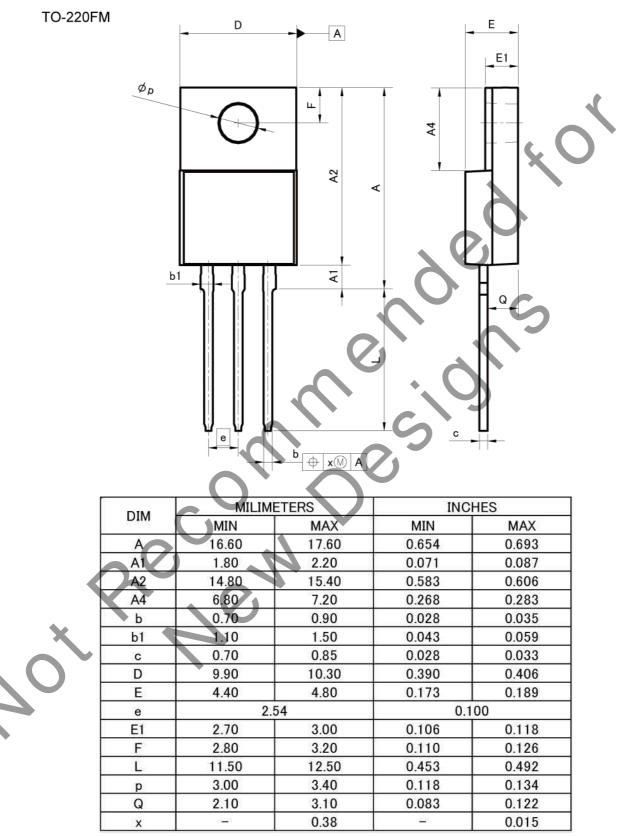


Measurement circuits





Dimensions



Dimension in mm/inches





Notice

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1. Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment ^(Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications								
	JAPAN	USA	EU	CHINA				
	CLASSⅢ		CLASS II b					

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CLASS III

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[a] Installation of protection circuits or other protective devices to improve system safety

CLASSⅢ

- [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
- 3. Our Products are designed and manufactured for use under standard conditions and not under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.

CLASS₩

- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power, exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.

De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.

- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

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